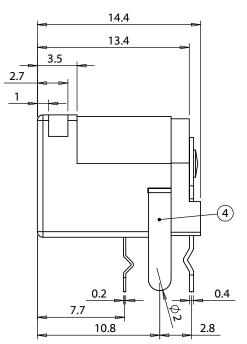
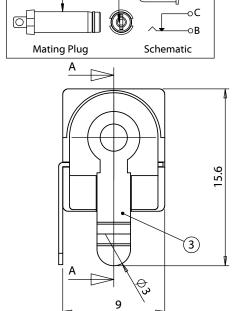


|Ø5.5





 		
10.8	6.5	
<u>.</u>	,	4.7
Revision:	Date:	Description:

Revision:	Date:	Description:	Prepared:
Α	9/26/2018	Initial release	
			Verified:
			Dimensions are in millimeters.
			Tolerances:
			$< 1.0: \pm 0.1 \text{ mm}$
			1.0 to 10.0: ± 0.2 mm > 10.0: ± 0.3 mm
			→ 10.0. ± 0.5 MM

Notes:

Function test: no open, no short circuit, no intermittent

Description:

Connector, dc jack 5.5x2.1 mm, PCB mount, 90°, silver plated, board lock

TENSILITY

tel 1.541.323.3228 800 877.670.7118 fax 1.541.323.4202 web tensility.com

Size: Part number: A 54-00131

Scale: 3:1

Sheet 1 of 2

3 2

Ratings

Maximum operating voltage: 48 V

Maximum operating current: 6.0 A (not mated under load)

Operating Temperature Range

-25 ~ 85 °C, relative humidity of 85% or less

Materials

1)Insulator: PBT, black

(2)Cover: PBT, black

(3)Terminal: brass, silver plated

(4)Terminal: brass, silver plated

(5)Spring contact: phosphor bronze, silver plated

(6) Center Pin: copper alloy, nickel plated

Electrical Requirements

Dielectric strength: 1 min @ 500 Vac

Insulation resistance: 100 M Ω @ 500 Vdc minimum

Contact resistance: $50 \text{ m}\Omega$ maximum

Mechanical Requirements

Insertion force: 0.7-1.5 kgf

Withdrawal force: 0.5-1.5 kgf

Life cycle: 5000 mating cycles while maintaining contact resistance: 100 mΩ maximum, withstand voltage: 500 Vac, 1 min

resistance: 100 mΩ maximum, withstand voltage: 500 Vac, 1 min Terminal strength: 150 gf applied to the terminal for 15 seconds in any direction while maintaining electrical characteristics and without damage or excessive looseness of terminals

Soldering

Solderability: 75% minimum coverage when terminals dipped 2mm in 245 \pm 5 °C solder bath for 3 \pm 0.5 seconds

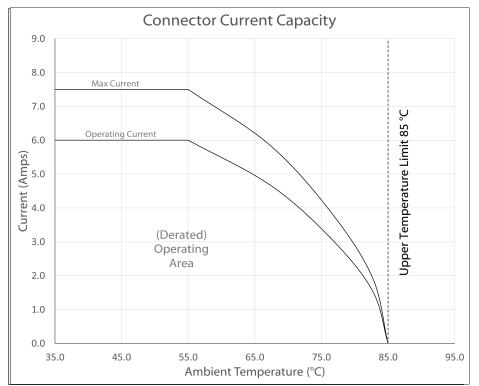
Solder bath durability: no deformation when immersed in 255 \pm 5 °C up to surface of the board 1.6 mm for 5 seconds or less

Solder iron durability: no deformation when exposed to 350 \pm 10 $^{\circ}$ C for 3 \pm 0.5 seconds

Environmental Requirements

Cold test: -25 ± 3 °C for 48 hours without deformation Heat test: 85 ± 2 °C, relative humidity 45-85% for 48 hours without deformation

Humidity test: 40 ± 2 °C, relative humidity 90-95% for 48 hours without deformation



Testing based on IEC 60512-5-2. Max current curve generated with isolated test article under controlled environmental conditions, and does not take into account external factors such as housings, mating cables, or other circuitry. Operating current curve (derated by 20% of maximum values) accounts for external factors, and manufacturing variation.

Wave Soldering Temperature Profile

Pb - Free Flow Profile

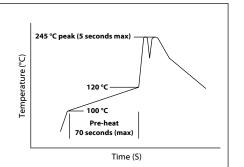
Solder temperature: 245 °C

Time: 5 seconds maximum

Pre-heat: 100 ~120°C

Time: 70 seconds maximum

Measure point: surface of the solder leads



Revision:	Date:	Description:	Prepared:	Notes:			
Α	9/26/2018	Initial release		Function test: no open, no short circuit, no		FNSII ITY	
			Tolerances:	intermittent	tel 1.541.323.3228 800 877.670.7118 fax 1.541.323.4202 web tensility.com Size: Part number:		
				Description:			
				Connector, dc jack 5.5x2.1 mm, PCB mount, 90°,	A	54-00131	
					Scale:	5:1 Sheet 2 of 2	

3 2